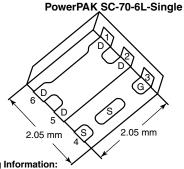
Vishay Siliconix

SiA439EDJ



P-Channel 20 V (D-S) MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	R _{DS(on)} (Ω) (Max.)	I _D (A) ^a	Q _g (Typ.)		
- 20	0.0165 at V _{GS} = - 4.5 V	- 28			
	0.0180 at V _{GS} = - 3.7 V	- 27	26.7 nC		
	0.0235 at V _{GS} = - 2.5 V	- 23	20.7 110		
	0.0420 at V _{GS} = - 1.8 V	- 6	Ī		



Ordering Information:

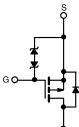
SiA439EDJ-T1-GE3 (Lead (Pb)-free and Halogen-free)

FEATURES

- TrenchFET[®] Power MOSFET
- Thermally Enhanced PowerPAK® SC-70 Package RoHS - Small Footprint Area COMPLIANT
 - Low On-Resistance
- 100 % R_q and UIS Tested
- Typical ESD Protection: 4000 V (HBM)
- Material categorization: For definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- · Portable Devices such as Smart Phones, Tablet PCs and Mobile Computing
 - Battery Switch
 - Load Switch
 - Power Management
- Marking Code BZX Part # code • X X X Lot Traceability and Date code



P-Channel MOSFET

HALOGEN

FREE

ABSOLUTE MAXIMUM RATINGS ($I_{\rm C} = 25$ °C, unless	otherwise noted)		
Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V _{DS}	- 20	V	
Gate-Source Voltage		V _{GS}	± 8		
	T _C = 25 °C		- 28		
	T _C = 70 °C		- 22		
Continuous Drain Current (T _J = 150 °C)	T _A = 25 °C	ID	- 12 ^{b, c}		
	T _A = 70 °C		- 9.5 ^{b, c}		
Pulsed Drain Current (t = 300 µs)		I _{DM}	- 60	— A	
Continuous Course Ducia Dia da Cumant	T _C = 25 °C		- 16		
Continuous Source-Drain Diode Current	T _A = 25 °C	I _S	- 2.9 ^{b, c}		
Single Avalanche Current		I _{AS}	- 11		
Single Avalanche Energy L = 0.1 mH		E _{AS}	5.8	mJ	
	T _C = 25 °C		19		
	T _C = 70 °C		12		
Maximum Power Dissipation	T _A = 25 °C	P _D	3.5 ^{b, c}	- W	
	T _A = 70 °C		2.2 ^{b, c}		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 50 to 150		
Soldering Recommendations (Peak Temperature) ^{d, e}		Ŭ	260	°C	

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient ^{b, f}	t ≤ 5 s	R _{thJA}	28	36	°C/W	
Maximum Junction-to-Case (Drain)	Steady State	R _{thJC}	5.3	6.5	0/10	

Notes

a. $T_C = 25 \ ^{\circ}C.$

b. Surface mounted on 1" x 1" FR4 board.

c. t = 5 s.

See solder profile (<u>www.vishay.com/doc?73257</u>). The PowerPAK SC-70 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed d. and is not required to ensure adequate bottom side solder interconnection.

Rework conditions: manual soldering with a soldering iron is not recommended for leadless components. e.

Maximum under steady state conditions is 80 °C/W. f.

Document Number: 62819

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static		· · · · · · · · · · · · · · · · · · ·					
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} = 0 V, I _D = - 250 μA				V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	L 050 A		- 13		mV/°C	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I _D = - 250 μΑ		2.9			
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$	- 0.4		- 1	V	
	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 8 V$			± 2		
Gate-Source Leakage		$V_{DS} = 0 V, V_{GS} = \pm 4.5 V$			± 0.5	μA	
		V _{DS} = - 20 V, V _{GS} = 0 V			- 1		
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = - 20 V, V _{GS} = 0 V, T _J = 55 °C					
On-State Drain Currenta	I _{D(on)}	$V_{DS} \le$ - 5 V, V_{GS} = - 4.5 V	- 10			Α	
		V _{GS} = - 4.5 V, I _D = - 5 A		0.0130	0.0165	Ω	
		V _{GS} = - 3.7 V, I _D = - 5 A		0.0140	0.0180		
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = - 2.5 V, I _D = - 4 A		0.0185	0.0235		
		V _{GS} = - 1.8 V, I _D = - 2 A		0.0300	0.0420		
Forward Transconductance ^a	g _{fs}	V _{GS} = - 10 V, I _D = - 5 A		24		S	
Dynamic ^b							
Input Capacitance	C _{iss}			2410			
Output Capacitance	C _{oss}	V _{DS} = - 10 V, V _{GS} = 0 V, f = 1 MHz		265		pF	
Reverse Transfer Capacitance	C _{rss}			245			
	Q _g Q _{gs}	V _{DS} = - 10 V, V _{GS} = - 8 V, I _D = - 12 A		45.5	69	1	
Total Gate Charge				26.7	40	nC	
Gate-Source Charge		V _{DS} = - 10 V, V _{GS} = - 4.5 V, I _D = - 12 A		4.5			
Gate-Drain Charge	Q _{gd}			6.4			
Gate Resistance	R _q	f = 1 MHz	1.8	9	18	Ω	
Turn-On Delay Time	t _{d(on)}			25	50		
Rise Time	t _r	$V_{DD} = -10 V, R_1 = 1 \Omega$		20	40	-	
Turn-Off Delay Time	t _{d(off)}	$I_D \cong -10$ A, $V_{GEN} = -4.5$ V, $R_g = 1$ Ω		95	190		
Fall Time	t _f			25	50		
Turn-On Delay Time	t _{d(on)}			10	20	ns	
Rise Time	t _r	$V_{DD} = -10 V, R_1 = 1 \Omega$		10	20	-	
Turn-Off Delay Time	t _{d(off)}	$I_D \cong$ - 10 A, V_{GEN} = - 8 V, R_g = 1 Ω		120	240		
Fall Time	t _f			25	50		
Drain-Source Body Diode Characteristi					1	1	
Continuous Source-Drain Diode Current	Is	T _C = 25 °C			- 16	A	
Pulse Diode Forward Current	I _{SM}	-			- 60		
Body Diode Voltage	V _{SD}	I _S = - 10 A, V _{GS} = 0 V		- 0.75	- 1.2	V	
Body Diode Reverse Recovery Time t _{rr}				16	35	ns	
Body Diode Reverse Recovery Charge	Q _{rr}			7	15	nC	
Reverse Recovery Fall Time	t _a	$I_F = -10 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, \text{T}_J = 25 ^\circ\text{C}$		7	-	- ns	
Reverse Recovery Rise Time	t _b			9			

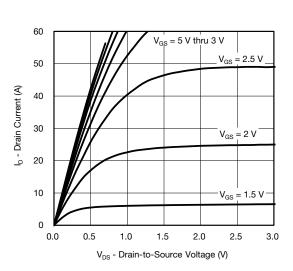
Notes

a. Pulse test; pulse width $\leq 300~\mu s,~duty~cycle \leq 2~\%.$

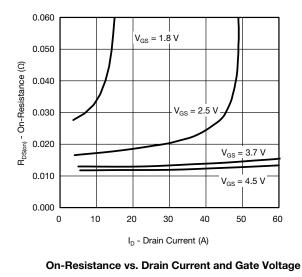
b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

2



Output Characteristics

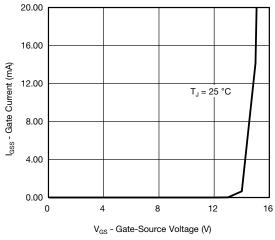


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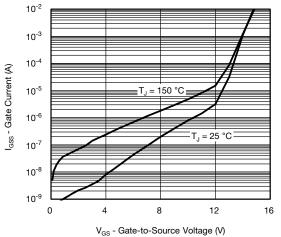
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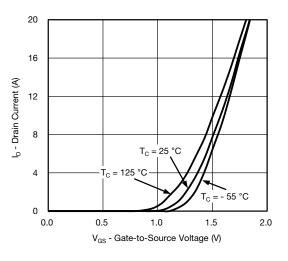


www.vishay.com

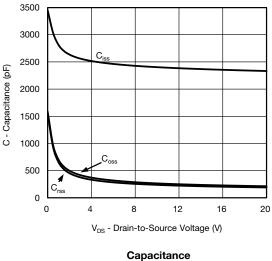
Gate Current vs. Gate-Source Voltage



Gate Current vs. Gate-to-Source Voltage



Transfer Characteristics



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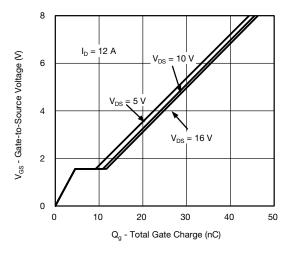
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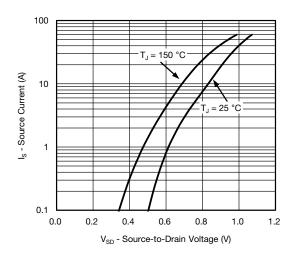


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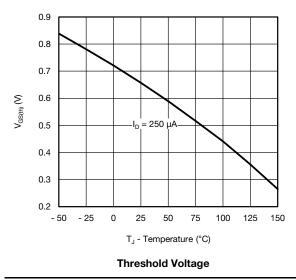
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

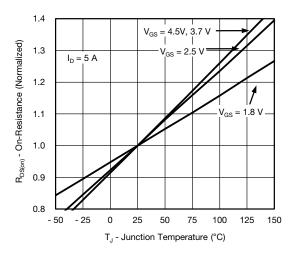


Gate Charge

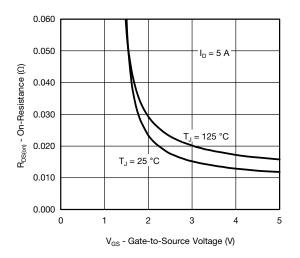


Soure-Drain Diode Forward Voltage

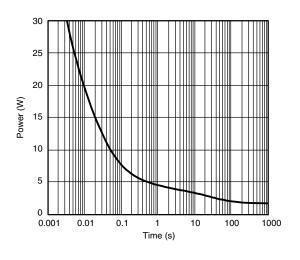




On-Resistance vs. Junction Temperature



On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power, Junction-to-Ambient

S13-0108-Rev. A, 21-Jan-13

4

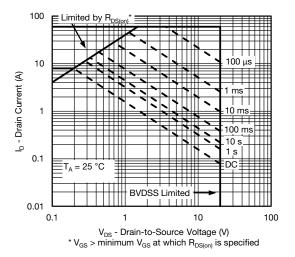
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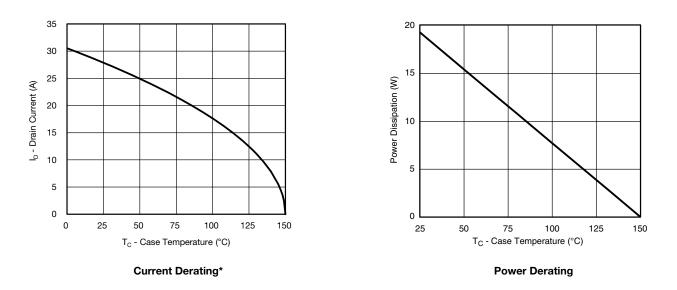


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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Safe Operating Area, Junction-to-Ambient



* The power dissipation P_D is based on $T_{J(max.)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

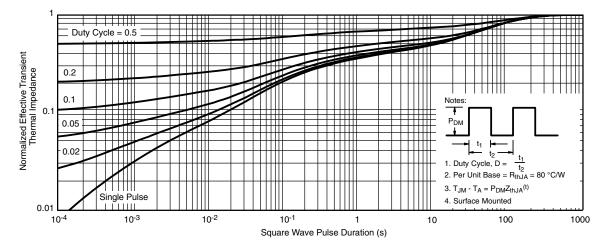
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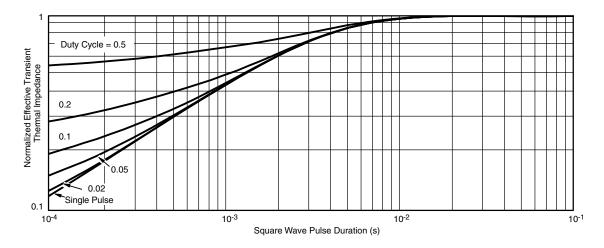
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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?62819.

6



PowerPAK[®] SC70-6L

VISHA

b PIN2 PIN1 PIN3 _ ₹



b

PIN3

__ ₿

PIN2

PIN1

¥

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¹



RECOMMENDED PAD LAYOUT FOR PowerPAK[®] SC70-6L Single



Dimensions in mm/(Inches)

Return to Index



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